

Technical Data Data Sheet N1191, Rev. B **Green Products**

208CMQ060 SCHOTTKY RECTIFIER

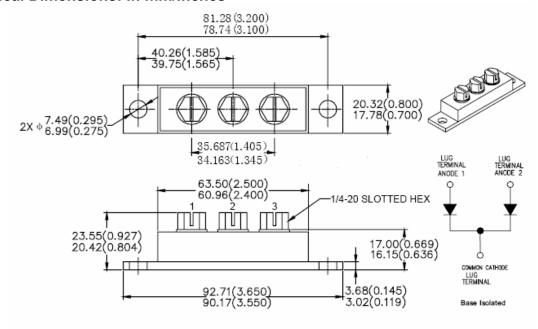
Applications:

- High current switching power supply Plating power supply Free-Wheeling diodes
- Reverse battery protection Converters UPS System Welding

Features:

- 150°C T_J operation
- Center tap module
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Low forward voltage drop
- High frequency operation
- · Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Mechanical Dimensions: In mm/Inches



Please Note: Anode 1 = Terminal 1; Anode 2 = Terminal 3; Common Cathode = Terminal 2 Suffix R Denotes for Reversed Polarity.

PRM4 (Isolated)

MARKING, MOLDING RESIN

Marking for 208CMQ060, 1st row SS YYWWL, 2nd row 208CMQ060
Where YY is the manufacture year
WW is the manufacture week code
L is the wafer's Lot Number
Molding resin
Epoxy resin UL:94V-0

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Maximum Ratings:

Characteristics	Symbol	Condition	Max.		Units
Peak Inverse Voltage	V_{RWM}	-	60		V
Max. Average Forward	I _{F(AV)}	50% duty cycle @T _C =90°C,	100	per leg	A
		rectangular wave form	200	per device	
Max. Peak One Cycle Non- Repetitive Surge Current (per leg)	I _{FSM}	8.3 ms, half Sine pulse		3840	А

Electrical Characteristics:

Characteristics	Symbol	Condition	Max.	Units
Max. Forward Voltage Drop	V_{F1}	@ 100A, Pulse, T _J = 25 °C	0.68	V
(per leg) *		@ 200A, Pulse, T _J = 25 °C	0.83	
	V_{F2}	@ 100A, Pulse, T _J = 125 °C	0.59	V
		@ 200A, Pulse, T _J = 125 °C	0.75	
Max. Reverse Current at DC	I _{R1}	$@V_R = rated V_R$	1.1	mA
condition		T _J = 25 °C	1,1	IIIA
Max. Reverse Current	I	$@V_R = rated V_R$	300	mA
	I _{R2}	T _J = 125 °C	300	ША
Max. Junction Capacitance	C _⊤	$@V_R = 5V, T_C = 25 ^{\circ}C$	6000	pF
	O ₁	f _{SIG} = 1MHz	0000	Рі
Typical Series Inductance	Ls	Measured lead to lead 5 mm	7.0	nH
(per leg)	LS	from package body	7.0	1111
Max. Voltage Rate of Change	dv/dt	-	10,000	V/μs
Insulation Voltage	V_{RMS}	-	1000	V

^{*} Pulse Width < 300µs, Duty Cycle <2%

Thermal-Mechanical Specifications:

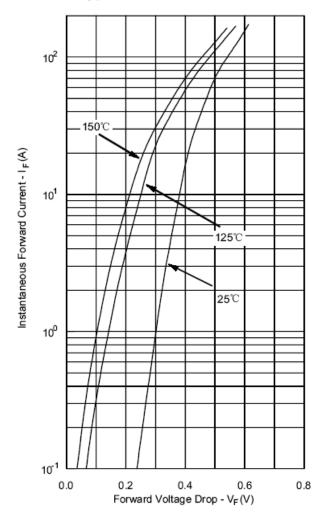
Characteristics	Symbol	Condition	Specifi	Units		
Max. Junction Temperature	T_J	-	-55 to	°C		
Max. Storage Temperature	T_{stg}	-	-55 to	°C		
Maximum Thermal Resistance Junction to Case (per leg)	$R_{ heta JC}$	DC operation	0.7		°C/W	
Maximum Thermal Resistance Junction to Case (per device)	$R_{ heta JC}$	DC operation	0.35		°C/W	
Typical Thermal Resistance, case to Heat Sink	$R_{\theta cs}$	Mounting surface, smooth and greased	0.10		°C/W	
Mounting Torque	Тм	-	Mounting Torque Terminal Torque	24(min) 35(max) 35(min) 46(max)	Kg-cm	
Approximate Weight	wt	-	79	g		
Case Style	PRM4 (Isolated)					



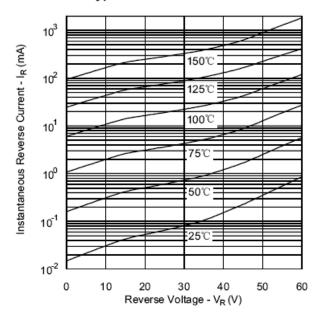


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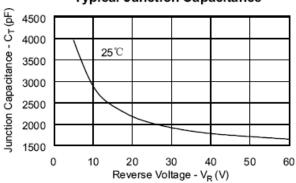
Typical Forward Characteristics



Typical Reverse Characteristics







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